

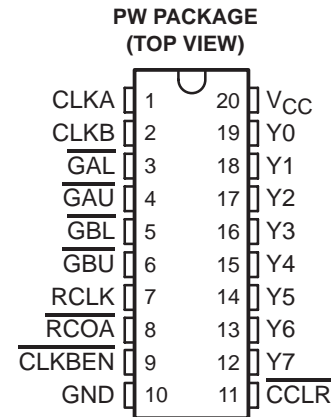
SN74LV8154-EP DUAL 16 BIT BINARY COUNTER WITH 3-STATE OUTPUT REGISTERS

SCLS704A – JULY 2006 – REVISED SEPTEMBER 2007

- **Controlled Baseline**
 - One Assembly Site
 - One Test Site
 - One Fabrication Site
- **Extended Temperature Performance of –55°C to 125°C**
- **Enhanced Diminishing Manufacturing Sources (DMS) Support**
- **Enhanced Product-Change Notification**
- **Qualification Pedigree†**
- **Can Be Used as Two 16 Bit Counters or a Single 32 Bit Counter**
- **2-V to 5.5-V V_{CC} Operation**
- **Max t_{pd} of 25 ns at 5 V (RCLK to Y)**
- **Typical V_{OLP} (Output Ground Bounce) <0.7 V at V_{CC} = 5 V, T_A = 25°C**
- **Typical V_{OHV} (Output V_{OH} Undershoot) >4.4 V at V_{CC} = 5 V, T_A = 25°C**
- **I_{off} Supports Partial-Power-Down Mode Operation**
- **Latch-Up Performance Exceeds 250 mA Per JESD 17**

- **ESD Protection Exceeds JESD 22**
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

† Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.



description/ordering information

The SN74LV8154 is a dual 16 bit binary counter with 3-state output registers, designed for 2-V to 5.5-V V_{CC} operation.

This 16 bit counter (A or B) feeds a 16 bit storage register and each storage register is further divided into an upper byte and lower byte. The $\overline{\text{GAL}}$, $\overline{\text{GAU}}$, $\overline{\text{GBL}}$, and $\overline{\text{GBU}}$ inputs are used to select the byte that needs to be output at Y0–Y7. CLKA is the clock for A counter and CLKB is the clock for B counter. RCLK is the clock for the A and B storage registers. All three clock signals are positive-edge triggered.

A 32 bit counter can be realized by connecting CLKA and CLKB together and by connecting $\overline{\text{RCOA}}$ to $\overline{\text{CLKBEN}}$. To ensure the high-impedance state during power up or power down, $\overline{\text{GAL}}$, $\overline{\text{GAU}}$, $\overline{\text{GBL}}$, and $\overline{\text{GBU}}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

ORDERING INFORMATION†

T _A	PACKAGE‡		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–55°C to 125°C	TSSOP – PW	Tape and reel	SN74LV8154MPWREP	LV8154ME

† For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

‡ Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/packaging.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

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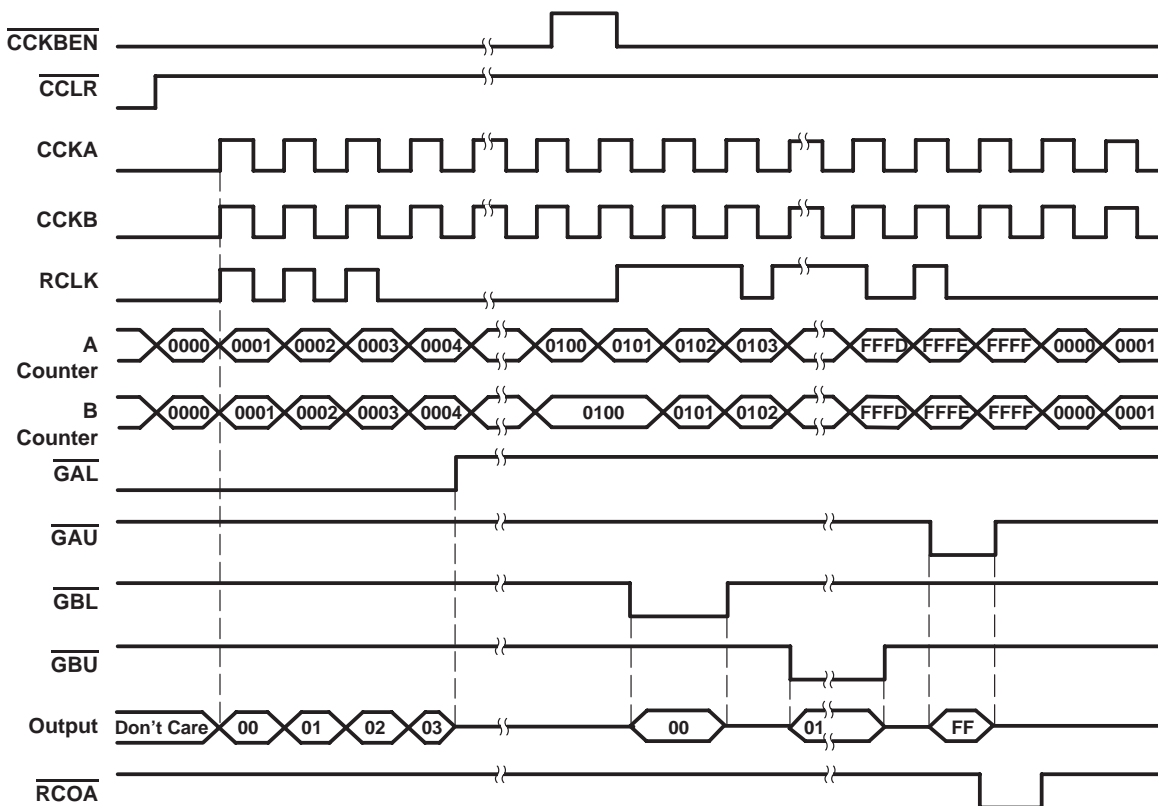
SCLS704A – JULY 2006 – REVISED SEPTEMBER 2007

FUNCTION TABLE
(each buffer)

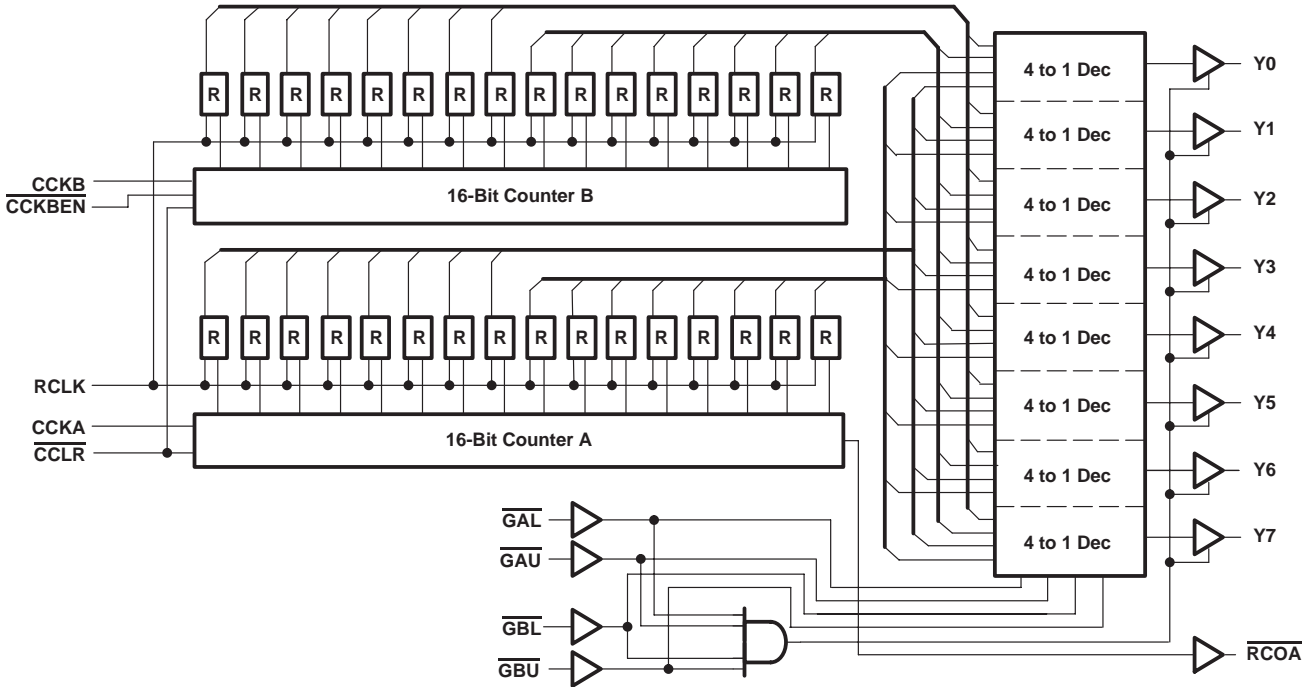
INPUTS				OUTPUT Y _n
$\overline{\text{GAL}}$	$\overline{\text{GAU}}$	$\overline{\text{GBL}}$	$\overline{\text{GBU}}$	
L	H	H	H	Lower byte in A register
H	L	H	H	Upper byte in A register
H	H	L	H	Lower byte in B register
H	H	H	L	Upper byte in B register
H	H	H	H	Z

Combinations of $\overline{\text{GAL}}$, $\overline{\text{GAU}}$, $\overline{\text{GBL}}$, and $\overline{\text{GBU}}$, other than those shown above, are prohibited. If more than one input is L at the same time, the output data (Y0–Y7) may be invalid.

timing diagram



block diagram



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	-0.5 V to 7 V
Input voltage range, V_I (see Note 1)	-0.5 V to 7 V
Voltage range applied to any output in the high-impedance or power-off state, V_O (see Note 1)	-0.5 V to 7 V
Output voltage range, V_O (see Note 1 and Note 2)	-0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$ V)	-20 mA
Output clamp current, I_{OK} ($V_O < 0$ V)	-50 mA
Continuous output current, I_O ($V_O = 0$ V to V_{CC})	± 35 mA
Continuous current through V_{CC} or GND	± 70 mA
Package thermal impedance, θ_{JA} (see Note 3):	83°C/W
Storage temperature range, T_{stg}	-65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 2. This value is limited to 5.5 V maximum.
 3. The package thermal impedance is calculated in accordance with JESD 51-7.

SN74LV8154-EP
DUAL 16 BIT BINARY COUNTER
WITH 3-STATE OUTPUT REGISTERS

SCLS704A – JULY 2006 – REVISED SEPTEMBER 2007

recommended operating conditions (see Note 4)

		V _{CC}	MIN	MAX	UNIT
V _{CC}	Supply voltage		2	5.5	V
V _{IH}	High-level input voltage	2 V	1.5		V
		3 V to 3.6 V	V _{CC} × 0.7		
		4.5 V to 5.5 V	V _{CC} × 0.7		
V _{IL}	Low-level input voltage	2 V		0.5	V
		3 V to 3.6 V		V _{CC} × 0.3	
		4.5 V to 5.5 V		V _{CC} × 0.3	
V _I	Input voltage		0	5.5	V
V _O	Output voltage	High or low state	0	V _{CC}	V
		3-state	0	5.5	
I _{OH}	Y _n outputs	2 V		-50	μA
		3 V to 3.6 V		-6	mA
		4.5 V to 5.5 V		-12	
	$\overline{\text{RCOA}}$	2 V		-50	μA
		3 V to 3.6 V		-6	mA
		4.5 V to 5.5 V		-12	
I _{OL}	Y _n outputs	2 V		50	μA
		3 V to 3.6 V		6	mA
		4.5 V to 5.5 V		12	
	$\overline{\text{RCOA}}$	2 V		50	μA
		3 V to 3.6 V		6	mA
		4.5 V to 5.5 V		12	
Δt/Δv	Input transition rise or fall rate	3 V to 3.6 V		100	ns/V
		4.5 V to 5.5 V		20	
T _A	Operating free-air temperature		-55	125	°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. See the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



SN74LV8154-EP
DUAL 16 BIT BINARY COUNTER
WITH 3-STATE OUTPUT REGISTERS
 SCLS704A – JULY 2006 – REVISED SEPTEMBER 2007

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V _{CC}	MIN	TYP	MAX	UNIT
V _{OH}	Y _n	I _{OH} = -50 μA	2 V	1.9			V
		I _{OH} = -6 mA	3 V	2.48			
		I _{OH} = -12 mA	4.5 V	3.8			
	$\overline{\text{RCOA}}$	I _{OH} = -50 μA	2 V	1.9			
		I _{OH} = -6 mA	3 V	2.48			
		I _{OH} = -12 mA	4.5 V	3.8			
V _{OL}	Y _n	I _{OL} = 50 μA	2 V			0.1	V
		I _{OL} = 6 mA	3 V			0.44	
		I _{OL} = 12 mA	4.5 V			0.55	
	$\overline{\text{RCOA}}$	I _{OL} = 50 μA	2 V			0.1	
		I _{OL} = 6 mA	3 V			0.44	
		I _{OL} = 12 mA	4.5 V			0.55	
I _I		V _I = 5.5 V or GND	0 V to 5.5 V			±1	μA
I _{OZ}		V _O = V _{CC} or GND	5.5 V			±5	μA
I _{CC}		V _I = V _{CC} or GND, I _O = 0	5.5 V			20	μA
I _{off}		V _I or V _O = 0 V to 5.5 V	0 V			5	μA
C _i		V _I = V _{CC} or GND	5 V		3		pF
C _o		V _O = V _{CC} or GND	5 V		5		pF

timing requirements over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)

			MIN	MAX	UNIT
t _w	Pulse duration	CLKA, CLKB, and RCLK high or low	10		ns
		$\overline{\text{CCLR}}$ low	22		
t _{su}	Setup time	$\overline{\text{CLKBEN}}$ low before CLKB↑	13		ns
		$\overline{\text{CCLR}}$ high (inactive) before CLKA↑ or CLKB↑	13		
		CLKA↑ or CLKB↑ before RCLK↑	13		
		RCLK↑ before $\overline{\text{GAL}}$, $\overline{\text{GAU}}$, $\overline{\text{GBL}}$, or $\overline{\text{GBU}}$ low	13		
		$\overline{\text{GAL}}$, $\overline{\text{GAU}}$, $\overline{\text{GBL}}$, or $\overline{\text{GBU}}$ high (inactive) before RCLK↑	13		
t _h	Hold time	$\overline{\text{CLKBEN}}$ low after CLKB↑	0		ns
		CLKA or CLKB after RCLK	0		
t _z [†]	Z-period	$\overline{\text{GAL}}$, $\overline{\text{GAU}}$, $\overline{\text{GBL}}$, and $\overline{\text{GBU}}$ all high before one of them switches low	200		ns

[†] t_z condition: C_L = 50 pF, R_L = 1 kΩ



SN74LV8154-EP
DUAL 16 BIT BINARY COUNTER
WITH 3-STATE OUTPUT REGISTERS

SCLS704A – JULY 2006 – REVISED SEPTEMBER 2007

timing requirements over recommended operating free-air temperature range, $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ (unless otherwise noted) (see Figure 1)

			MIN	MAX	UNIT
t_w	Pulse duration	CLKA, CLKB, and RCLK high or low	10		ns
		$\overline{\text{CCLR}}$ low	20		
t_{su}	Setup time	$\overline{\text{CLKBEN}}$ low before CLKB \uparrow	10		ns
		$\overline{\text{CCLR}}$ high (inactive) before CLKA \uparrow or CLKB \uparrow	10		
		CLKA \uparrow or CLKB \uparrow before RCLK \uparrow	10		
		RCLK \uparrow before $\overline{\text{GAL}}$, $\overline{\text{GAU}}$, $\overline{\text{GBL}}$, or $\overline{\text{GBU}}$ low	10		
		$\overline{\text{GAL}}$, $\overline{\text{GAU}}$, $\overline{\text{GBL}}$, or $\overline{\text{GBU}}$ high (inactive) before RCLK \uparrow	10		
t_h	Hold time	$\overline{\text{CLKBEN}}$ low after CLKB \uparrow	0		ns
		CLKA or CLKB after RCLK	0		
t_z^\dagger	Z period	$\overline{\text{GAL}}$, $\overline{\text{GAU}}$, $\overline{\text{GBL}}$, and $\overline{\text{GBU}}$ all high before one of them switches low	200		ns

$^\dagger t_z$ condition: $C_L = 50\text{ pF}$, $R_L = 1\text{ k}\Omega$

switching characteristics over recommended operating free-air temperature range, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$	MIN	MAX	UNIT
				TYP			
f_{MAX}			$C_L = 50\text{ pF}$		25		MHz
t_{pd}	RCLK	Y	$C_L = 50\text{ pF}$	25	1	42	ns
	CLKA	$\overline{\text{RCOA}}$		28	1	46	
t_{PLH}	$\overline{\text{CCLR}}$	$\overline{\text{RCOA}}$		20	1	35	ns
t_{en}	$\overline{\text{GAL}}$, $\overline{\text{GAU}}$, $\overline{\text{GBL}}$, $\overline{\text{GBU}}$	Y		30	1	50	ns
t_{dis}	$\overline{\text{GAL}}$, $\overline{\text{GAU}}$, $\overline{\text{GBL}}$, $\overline{\text{GBU}}$	Y		14	1	24	ns

switching characteristics over recommended operating free-air temperature range, $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$	MIN	MAX	UNIT
				TYP			
f_{MAX}			$C_L = 50\text{ pF}$		25		MHz
t_{pd}	RCLK	Y	$C_L = 50\text{ pF}$	16	1	27	ns
	CLKA	$\overline{\text{RCOA}}$		17	1	28	
t_{PLH}	$\overline{\text{CCLR}}$	$\overline{\text{RCOA}}$		13	1	21	ns
t_{en}	$\overline{\text{GAL}}$, $\overline{\text{GAU}}$, $\overline{\text{GBL}}$, $\overline{\text{GBU}}$	Y		18	1	30	ns
t_{dis}	$\overline{\text{GAL}}$, $\overline{\text{GAU}}$, $\overline{\text{GBL}}$, $\overline{\text{GBU}}$	Y		9	1	16	ns



SN74LV8154-EP
DUAL 16 BIT BINARY COUNTER
WITH 3-STATE OUTPUT REGISTERS
SCLS704A – JULY 2006 – REVISED SEPTEMBER 2007

noise characteristics, $V_{CC} = 5\text{ V}$, $C_L = 50\text{ pF}$

PARAMETER		$T_A = 25^\circ\text{C}$	UNIT
		TYP	
$V_{OL(P)}$	Quiet output, maximum dynamic V_{OL}	0.7	V
$V_{OL(V)}$	Quiet output, minimum dynamic V_{OL}	-0.75	V
$V_{OH(V)}$	Quiet output, minimum dynamic V_{OH}	4.4	V

operating characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

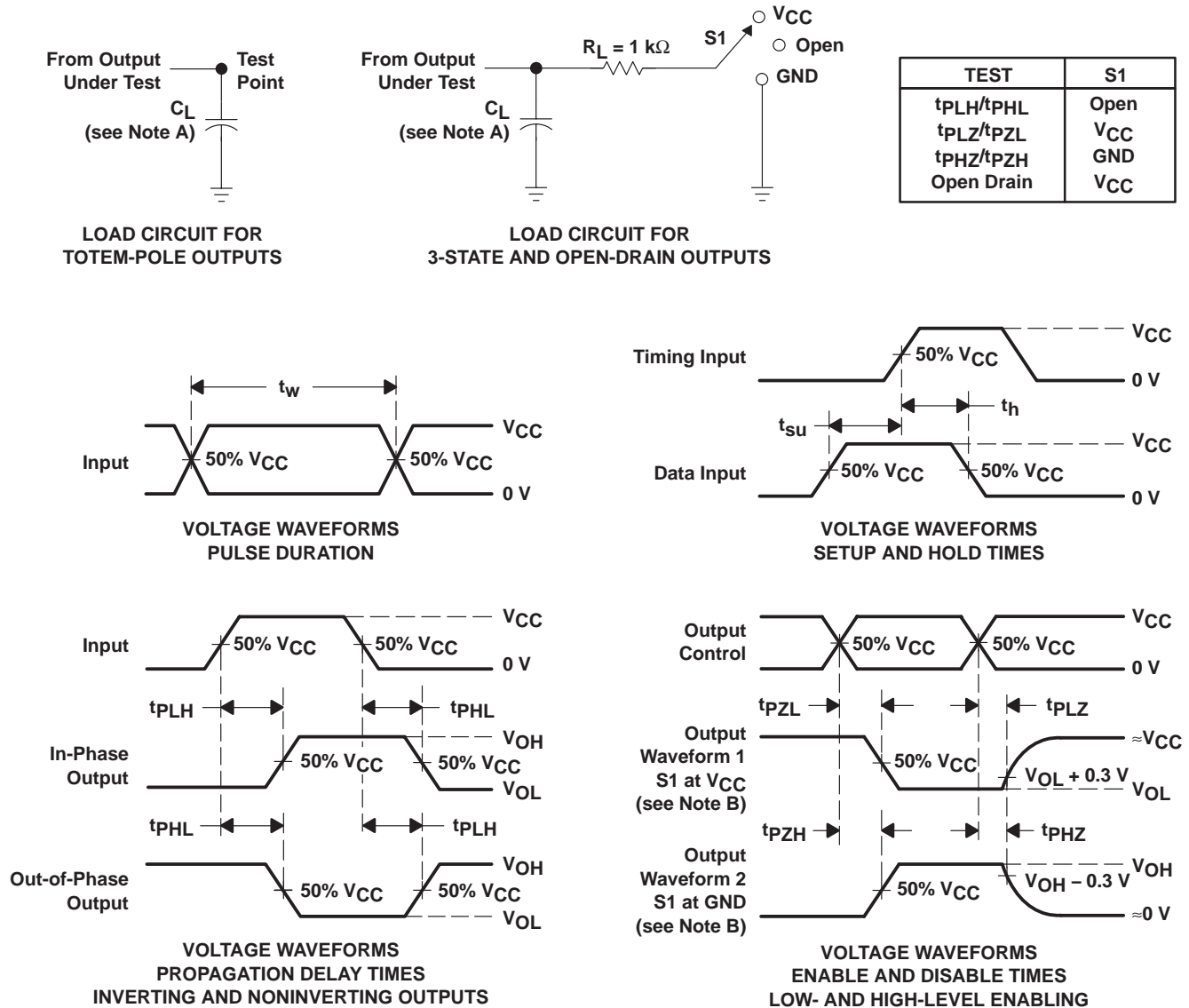
PARAMETER	TEST CONDITIONS	TYP	UNIT
C_{pd} Power dissipation capacitance	$C_L = \text{No load}$, $CCLK = 10\text{ MHz}$, $RCLK = 1\text{ MHz}$	56	pF



SN74LV8154-EP DUAL 16 BIT BINARY COUNTER WITH 3-STATE OUTPUT REGISTERS

SCLS704A – JULY 2006 – REVISED SEPTEMBER 2007

PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR $\leq 1\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 3\text{ ns}$, $t_f \leq 3\text{ ns}$.
 - D. The outputs are measured one at a time, with one input transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PHL} and t_{PLH} are the same as t_{pd} .
 - H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuits and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74LV8154MPWREP	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
V62/06662-01XE	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF SN74LV8154-EP :

- Catalog: [SN74LV8154](#)

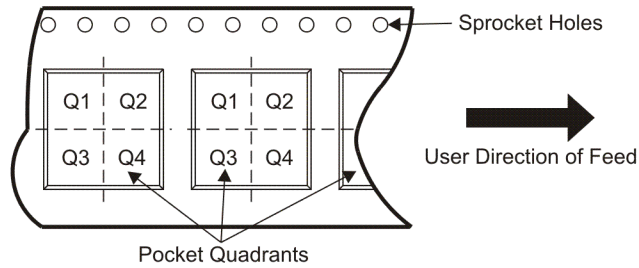
NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

TAPE AND REEL INFORMATION



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LV8154MPWREP	TSSOP	PW	20	2000	330.0	16.4	6.95	7.1	1.6	8.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LV8154MPWREP	TSSOP	PW	20	2000	333.2	345.9	28.6

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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